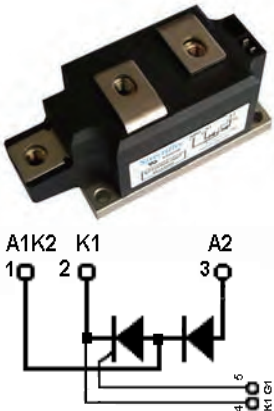


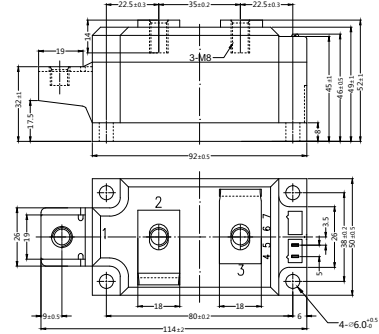
STD320GK26BT

Thyristor-Diode Modules



Type	V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V
STD320GK08BT	900	800
STD320GK12BT	1300	1200
STD320GK14BT	1500	1400
STD320GK16BT	1700	1600
STD320GK18BT	1900	1800
STD320GK20BT	2100	2000
STD320GK22BT	2300	2200
STD320GK24BT	2500	2400
STD320GK26BT	2700	2600

Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
I_{TRMS} , I_{FRMS} I_{TAVM} , I_{FAVM}	$T_{VJ}=T_{VJM}$; 50Hz $T_C=85^\circ\text{C}$; 180°sine	502 320	A
I_{TSM} , I_{FSM}	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	9100 10900	A
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	8000 9600	
$\int i^2 dt$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	414000 496000	A^2s
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	320000 384000	
$(di/dt)_{cr}$	$T_{VJ}=T_{VJM}$ f=50Hz, $t_p=200\mu\text{s}$ $V_D=2/3V_{DRM}$ $I_G=0.5\text{A}$ $di_G/dt=0.5\text{A}/\mu\text{s}$ repetitive	150	A/ μs
	non repetitive	500	
$(dv/dt)_{cr}$	$T_{VJ}=T_{VJM}$; $R_{GK}=\infty$; method 1 (linear voltage rise) $V_{DR}=2/3V_{DRM}$	1000	V/ μs
P_{GM}	$T_{VJ}=T_{VJM}$ $I_T=I_{TAVM}$ $t_p=30\mu\text{s}$ $t_p=500\mu\text{s}$	120 60	W
P_{GAV}		8	W
V_{RGM}		10	V
T_{VJ} T_{VJM} T_{stg}		-40...+125 125 -40...+125	$^\circ\text{C}$
V_{ISOL}	50/60Hz, RMS $I_{ISOL}\leq 1\text{mA}$ t=1min t=1s	3000 3600	V~
M_d	Mounting torque (M6)	5	Nm
	Terminal connection torque (M8)	12	
Weight	Typical	783	g

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Symbol	Test Conditions	Characteristic Values	Unit
I_{RRM}, I_{DRM}	$T_{VJ}=T_{VJM}; V_R=V_{RRM}; V_D=V_{DRM}$	60	mA
V_{TM}	$I_{TM}=960A; T_{VJ}=25^{\circ}C$	$\leq 1800V$	2000-2600V
		1.85	2.20
V_{TO}	For power-loss calculations only ($T_{VJ}=T_{VJM}$)	0.8	V
r_T		0.6	m Ω
V_{GT}	$V_D=6V;$ $T_{VJ}=25^{\circ}C$ $T_{VJ}=-40^{\circ}C$	2	V
		2.6	
I_{GT}	$V_D=6V;$ $T_{VJ}=25^{\circ}C$ $T_{VJ}=-40^{\circ}C$	200	mA
		250	
V_{GD}	$T_{VJ}=T_{VJM}; V_D=2/3V_{DRM}$	0.25	V
I_{GD}	$T_{VJ}=T_{VJM}; V_D=2/3V_{DRM}$	10	mA
I_L	$T_{VJ}=25^{\circ}C; t_p=30\mu s; V_D=6V$ $I_G=0.45A; di_G/dt=0.45A/\mu s$	1200	mA
I_H	$T_{VJ}=25^{\circ}C; V_D=6V; R_{GK}=\infty$	300	mA
t_{gd}	$T_{VJ}=25^{\circ}C; V_D=1/2V_{DRM}$ $I_G=0.5A; di_G/dt=0.5A/\mu s$	3	us
t_q	$T_{VJ}=T_{VJM}; I_T=250A; t_p=200\mu s; -di/dt=10A/\mu s$ $V_R=100V; dv/dt=20V/\mu s; V_D=2/3V_{DRM}$	typ. 250	us
Q_S	$T_{VJ}=T_{VJM}; I_T, I_F=250A; -di/dt=50A/\mu s$	650	uC
I_{RM}		235	A
R_{thJC}	per thyristor/diode; DC current per module	0.111	K/W
		0.056	
R_{thCH}	per thyristor/diode; DC current per module	0.04	K/W
		0.02	
d_s	Creeping distance on surface	12.7	mm
d_A	Creepage distance in air	9.6	mm
a	Maximum allowable acceleration	50	m/s ²

FEATURES

- * International standard package
- * Isolation voltage 3600 V~
- * Pressure Contacts Technology
- * UL File NO.E310749
- * RoHS Compliant

APPLICATIONS

- * Motor control
- * Power converter
- * Heat and temperature control for industrial furnaces and chemical processes
- * Lighting control
- * Contactless switches

ADVANTAGES

- * Space and weight savings
- * Simple mounting
- * Improved temperature and power cycling
- * Reduced protection circuits



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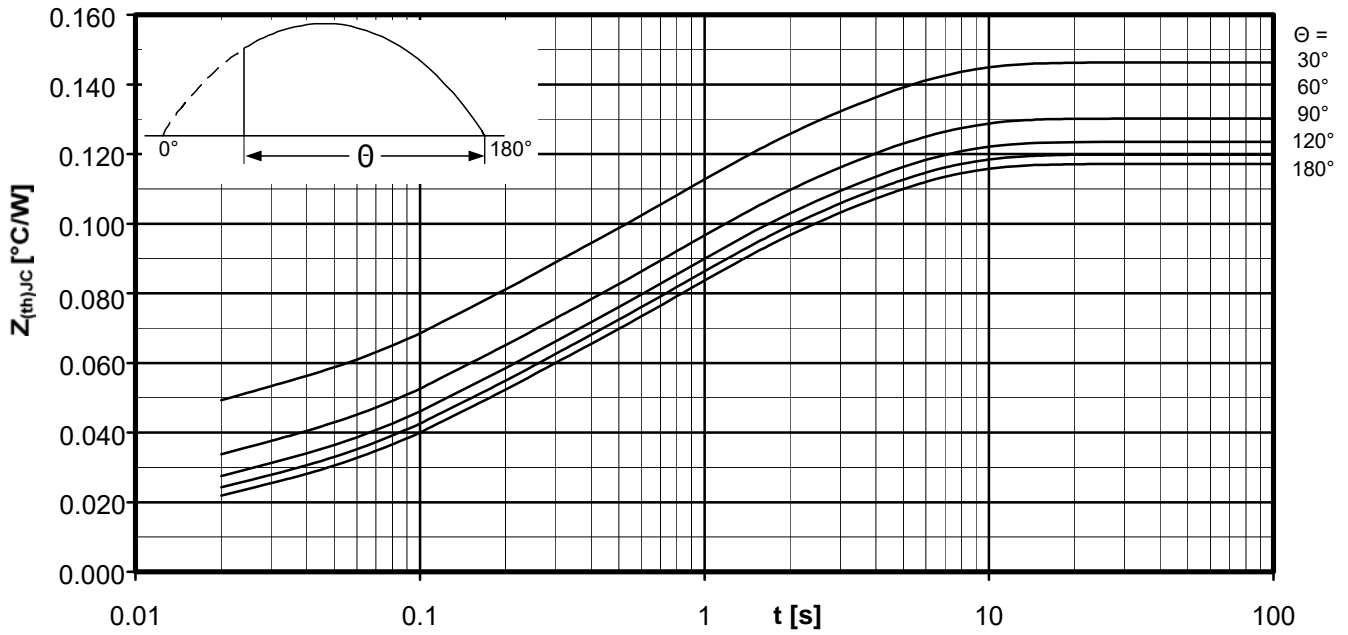


Fig.1 Transient thermal impedance per arm $Z_{thJC} = f(t)$ Sinusoidal current Parameter:
Current conduction angle Θ

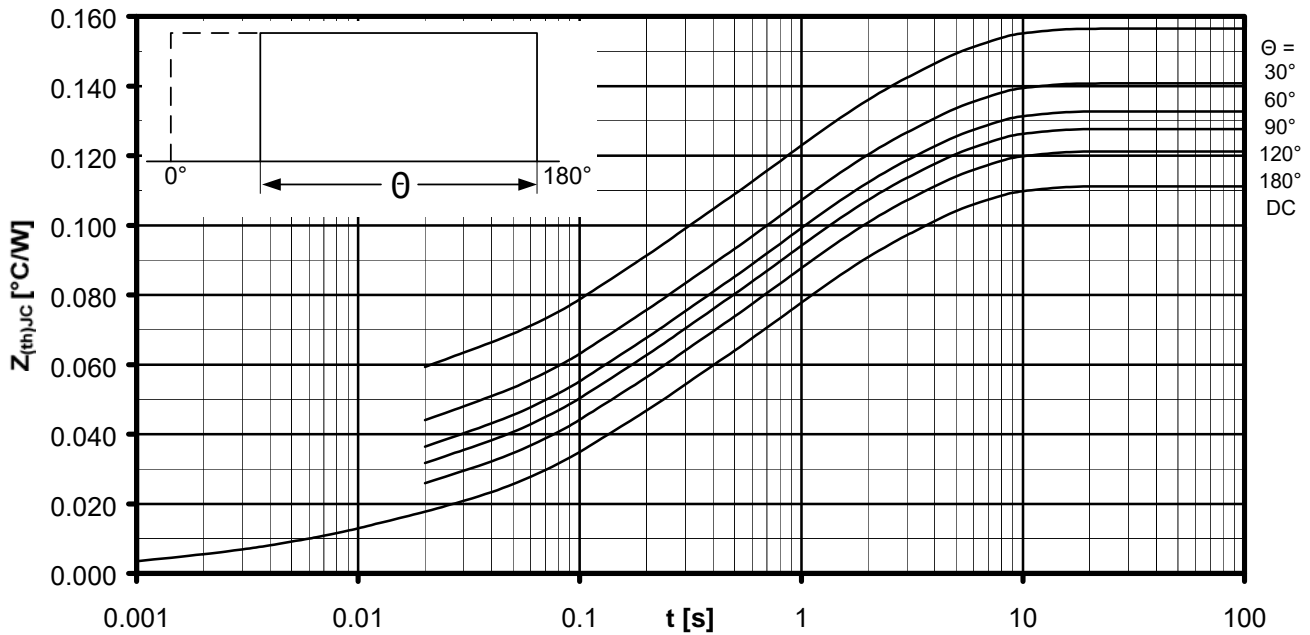


Fig.2 Transient thermal impedance per arm $Z_{thJC} = f(t)$ Rectangular current Parameter:
Current conduction angle Θ

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Thyristor-Diode Modules

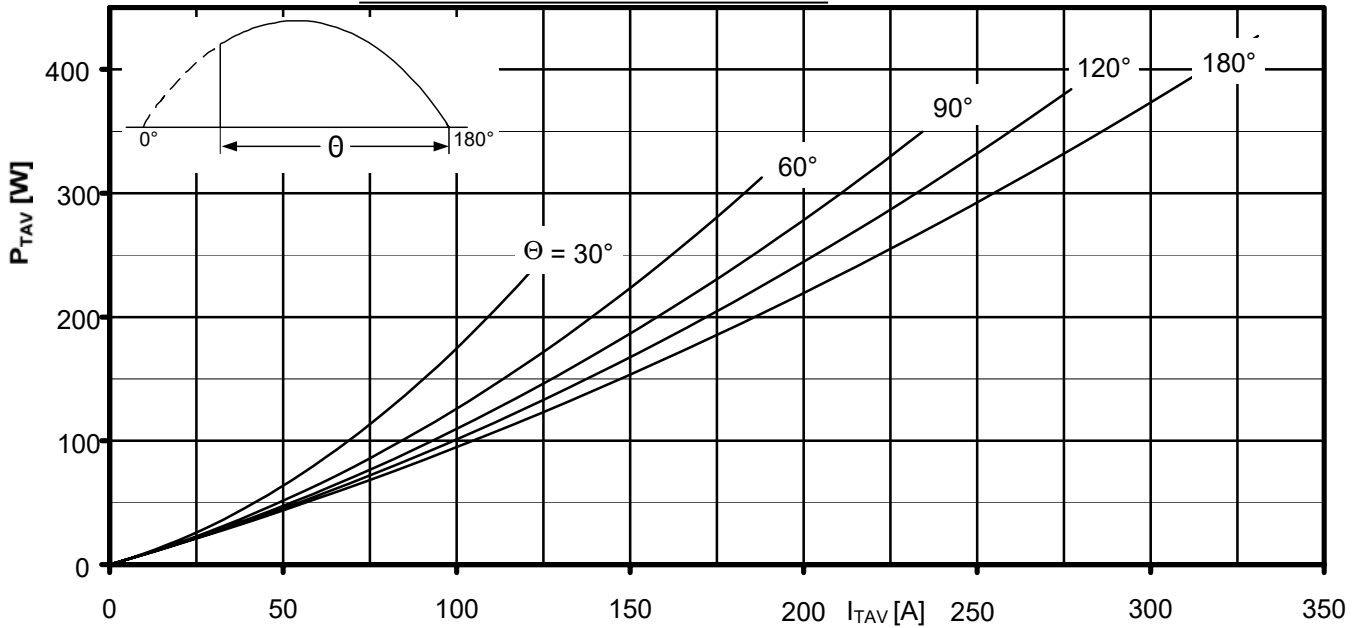


Fig.3 On-state power loss per arm $P_{TAV} = f(I_{TAV})$ Sinusoidal current
 Current load per arm
 Calculation base P_{TAV} (switching losses should be considered separately) Parameter:
 Current conduction angle Θ

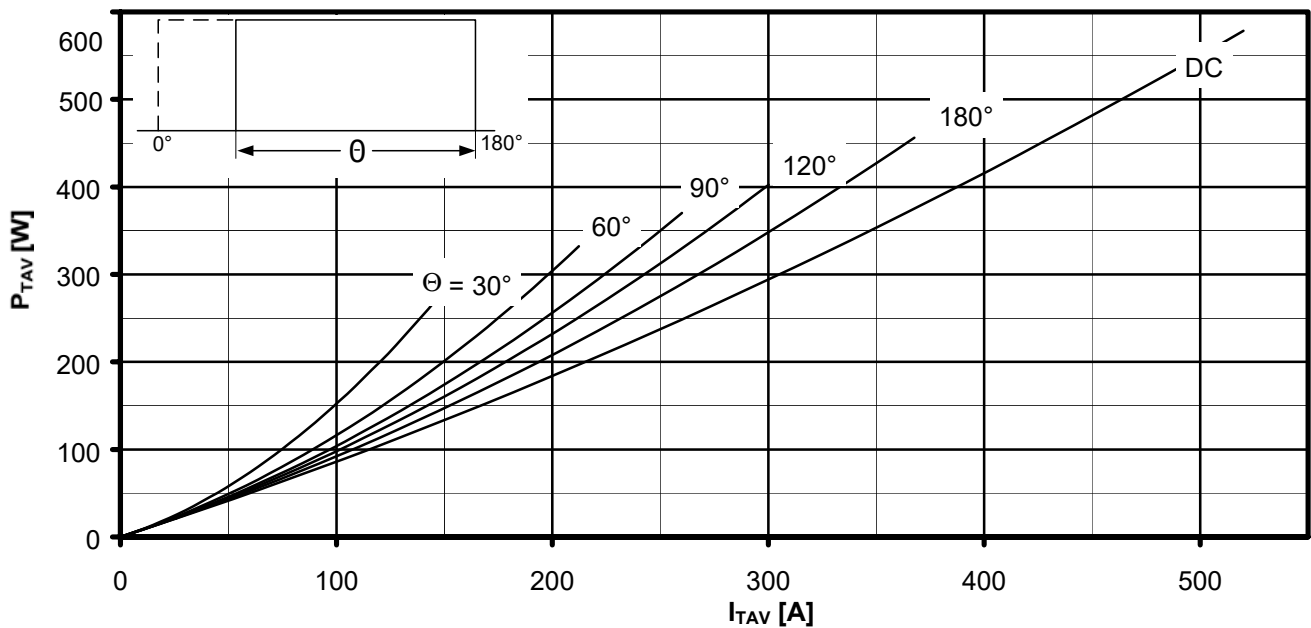


Fig.4 On-state power loss per arm $P_{TAV} = f(I_{TAV})$
 Rectangular current Current load per arm
 Calculation base P_{TAV} (switching losses should be considered separately) Parameter:
 Current conduction angle Θ

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Thyristor-Diode Modules

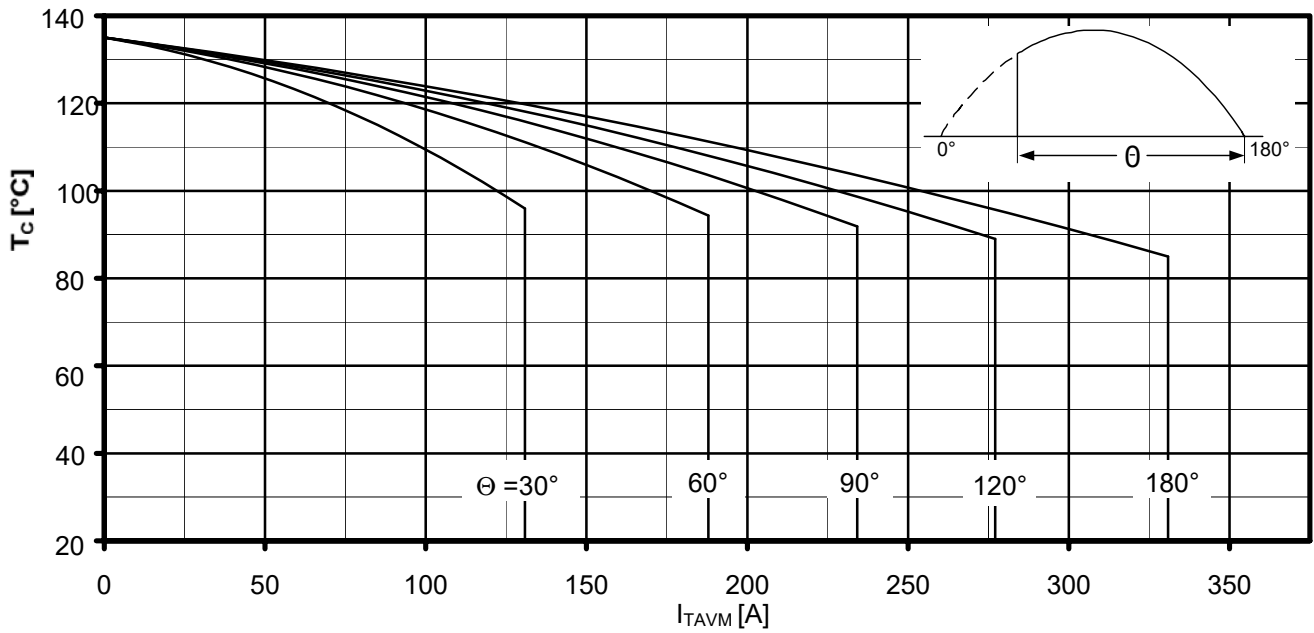


Fig.6 Maximum allowable case temperature $T_C = f(I_{TAVM})$
 Sinusoidal current Current load per arm
 Calculation base P_{TAV} (switching losses should be considered separately) Parameter:
 Current conduction angle Θ

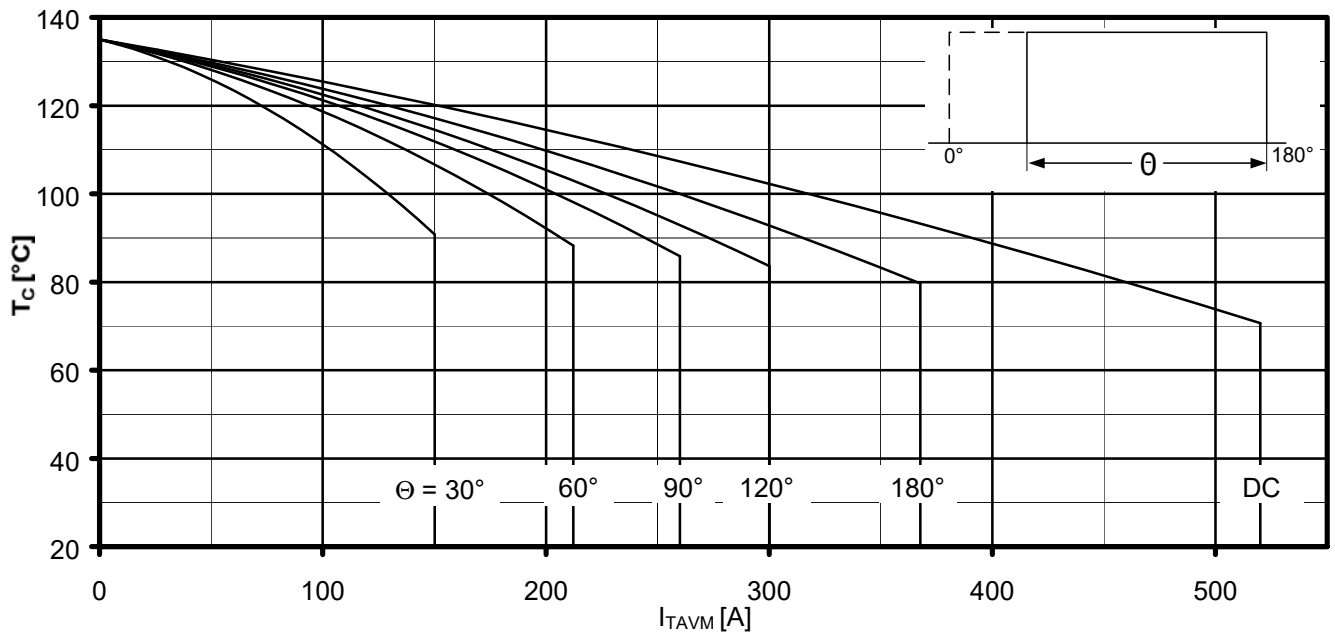


Fig.7 Maximum allowable case temperature $T_C = f(I_{TAVM})$
 Rectangular current Current load per arm
 Calculation base P_{TAV} (switching losses should be considered separately) Parameter:
 Current conduction angle Θ



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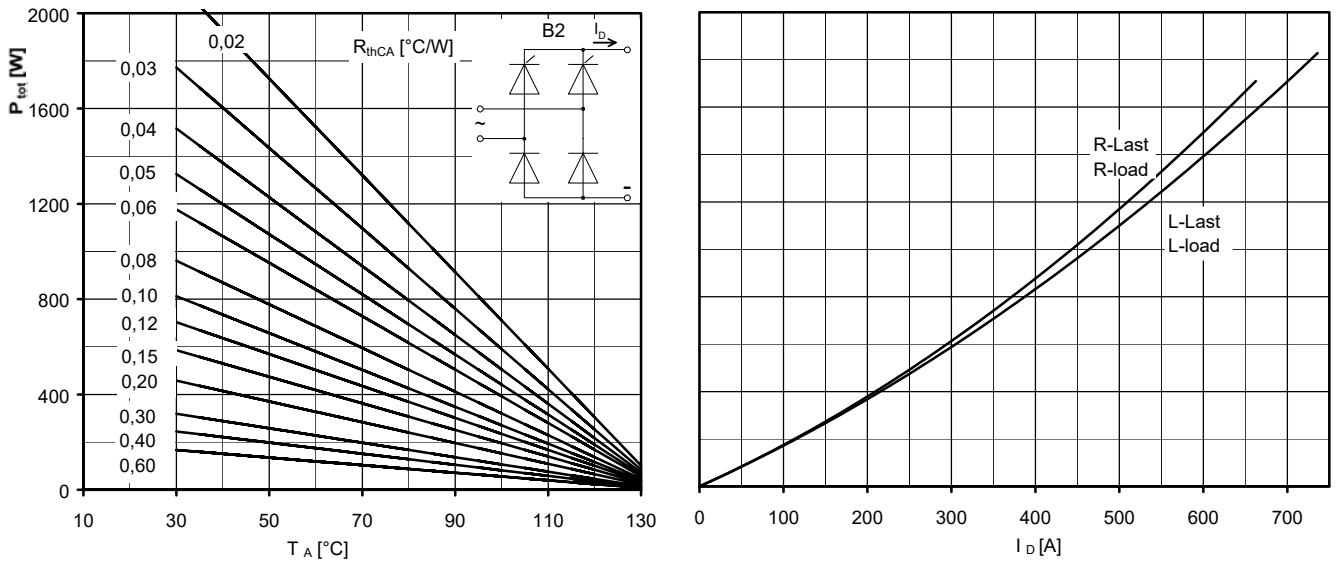


Fig.8 Maximum rated output current I_D Two-pulse bridge circuit
 Total power dissipation at circuit P_{tot} Parameter:
 Thermal resistance cases to ambient R_{thCA}

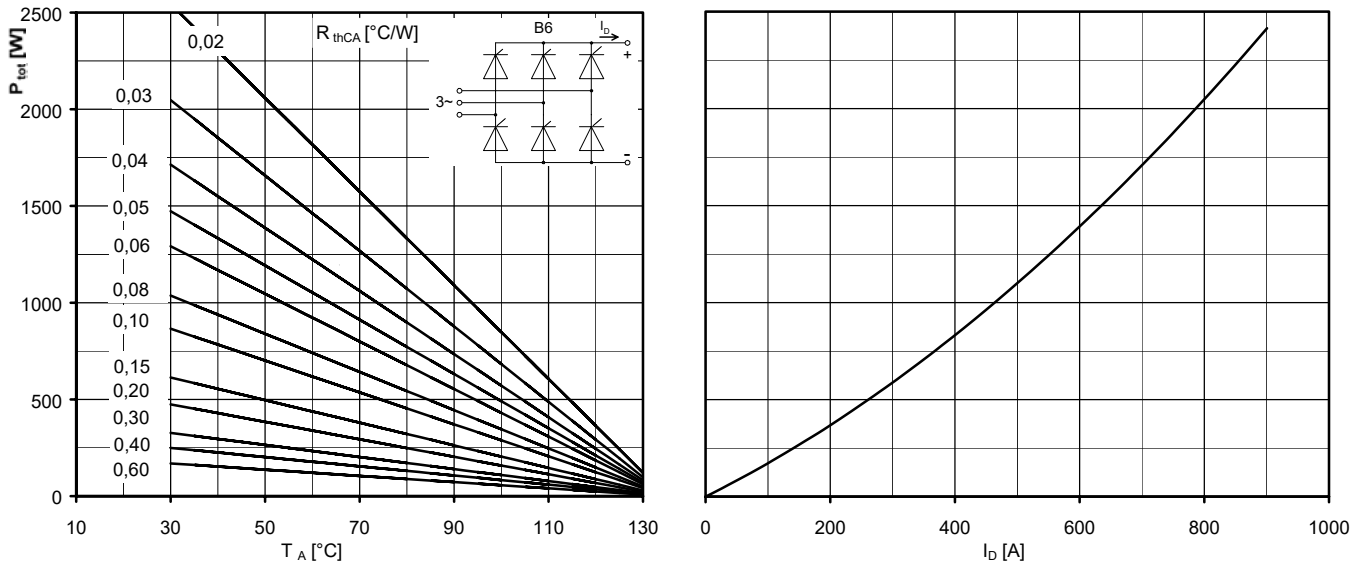


Fig.9 Maximum rated output current I_D Six-pulse bridge circuit
 Total power dissipation at circuit P_{tot} Parameter:
 Thermal resistance cases to ambient R_{thCA}

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Thyristor-Diode Modules

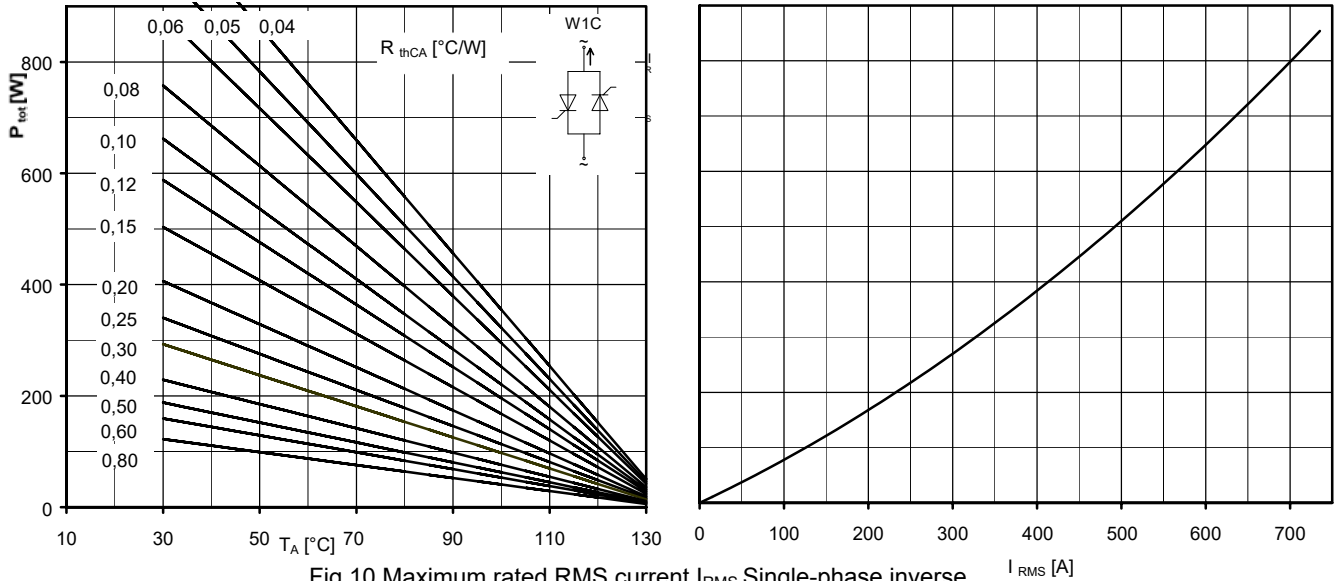


Fig.10 Maximum rated RMS current I_{RMS} Single-phase inverse parallel circuit

Total power dissipation at circuit P_{tot} Parameter:

Thermal resistance case to ambient R_{thCA}

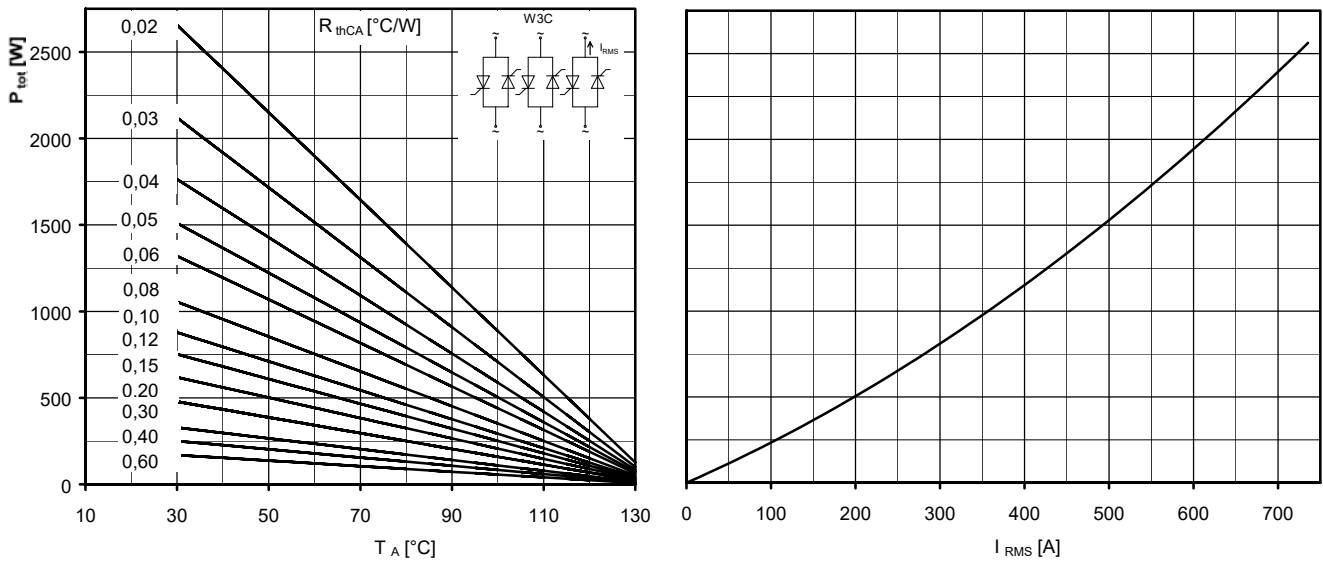


Fig.11 Maximum rated RMS current I_{RMS}

Three-phase inverse parallel circuit

Total power dissipation at circuit P_{tot} Parameter: Thermal resistance cases to ambient R_{thCA}

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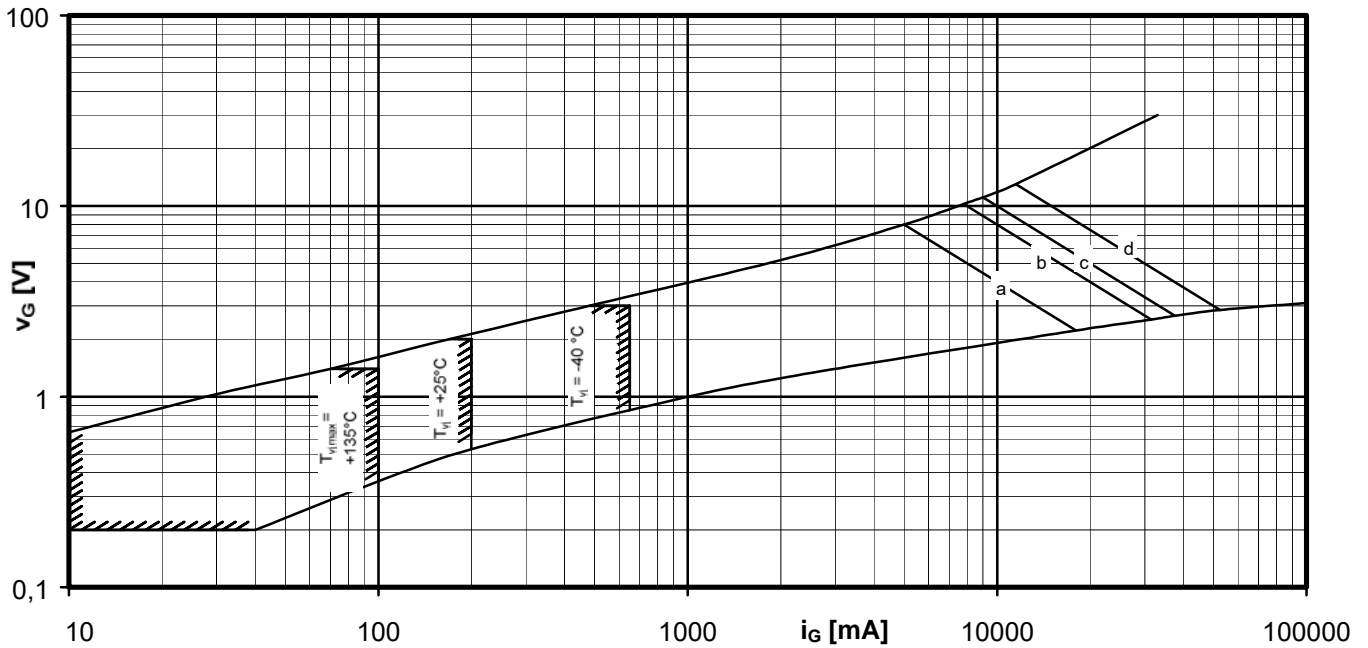


Fig.12 Gate characteristic $v_G = f(i_G)$ with triggering area for $V_D = 6\text{ V}$
 Maximum rated peak gate power dissipation
 PGM = $f(t_g)$: a - 40 W/10ms b - 80 W/1ms c - 100 W/0,5ms d - 150W/0,1ms

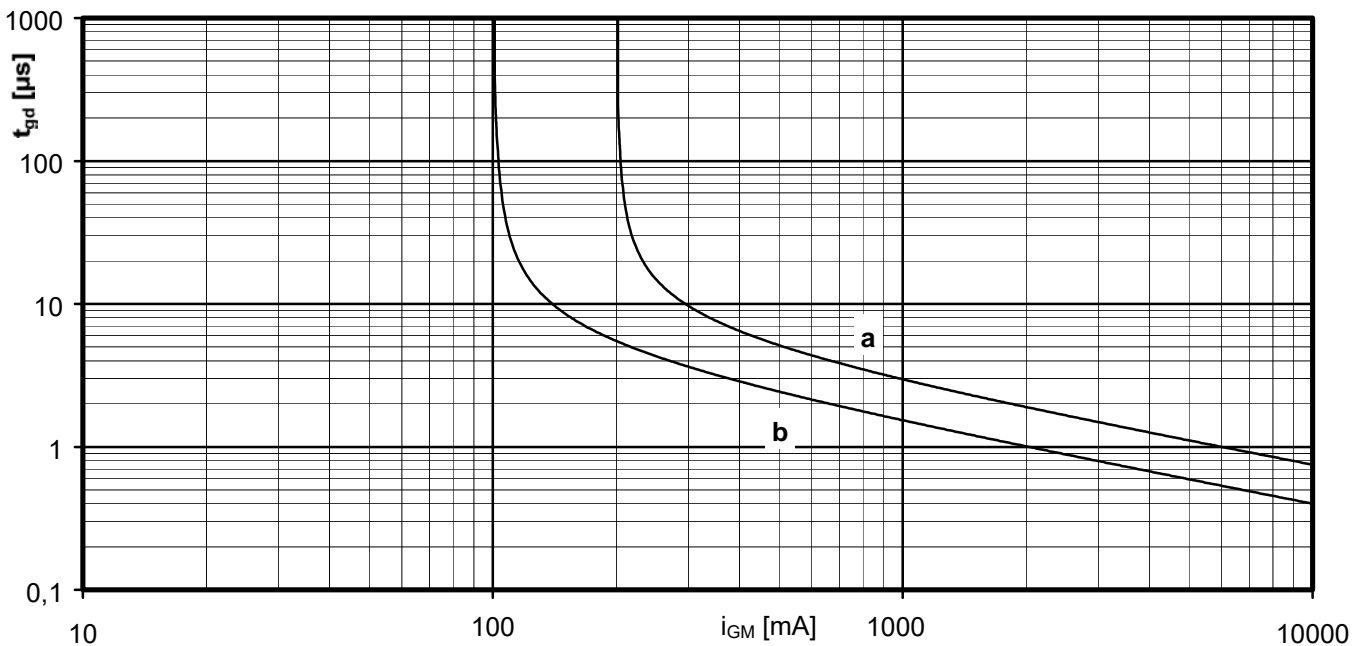


Fig.13 Gate controlled delay time $t_{gd} = f(i_G)$ $T_{vj} = 25^\circ\text{C}$,
 $di_G/dt = i_{GM}/1\mu\text{s}$
 a - Limiting characteristic
 b - Typical characteristic

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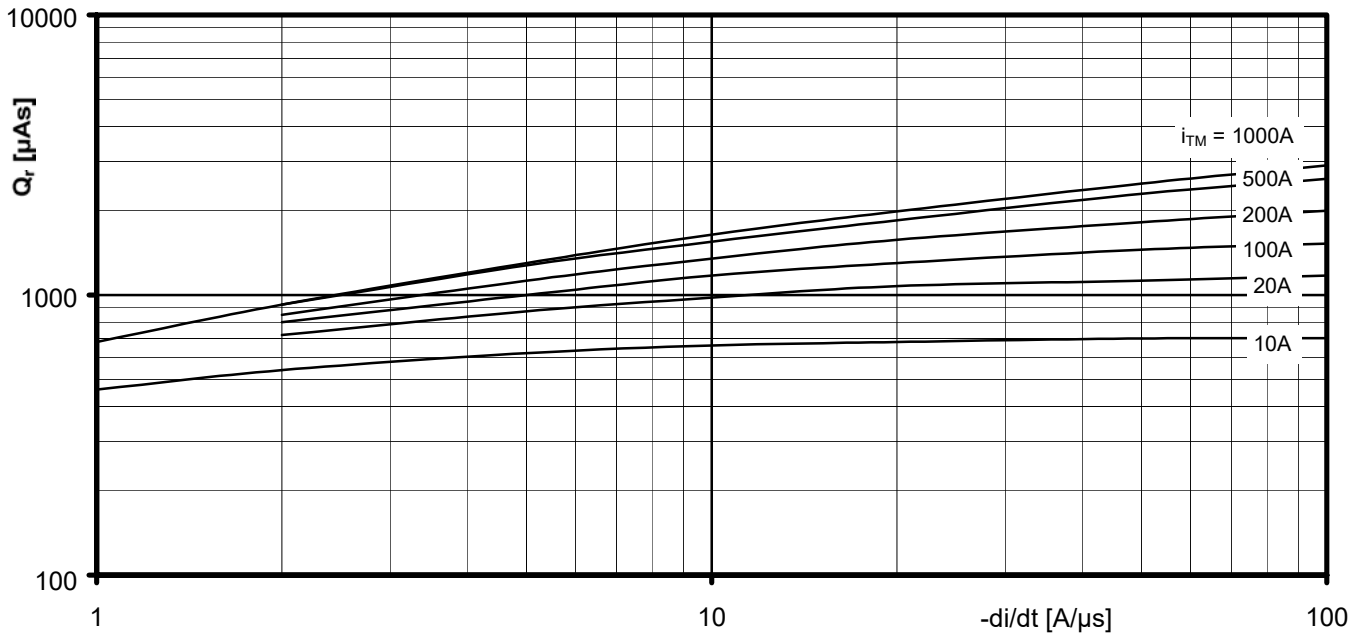


Fig. 14 Recovered charge $Q_r = f(-di/dt)$
 $T_{vj} = T_{vjmax}$, $V_R \leq 0,5 V_{RRM}$, $V_{RM} = 0,8$
 V_{RRM} Parameter: On-state current i_{TM}

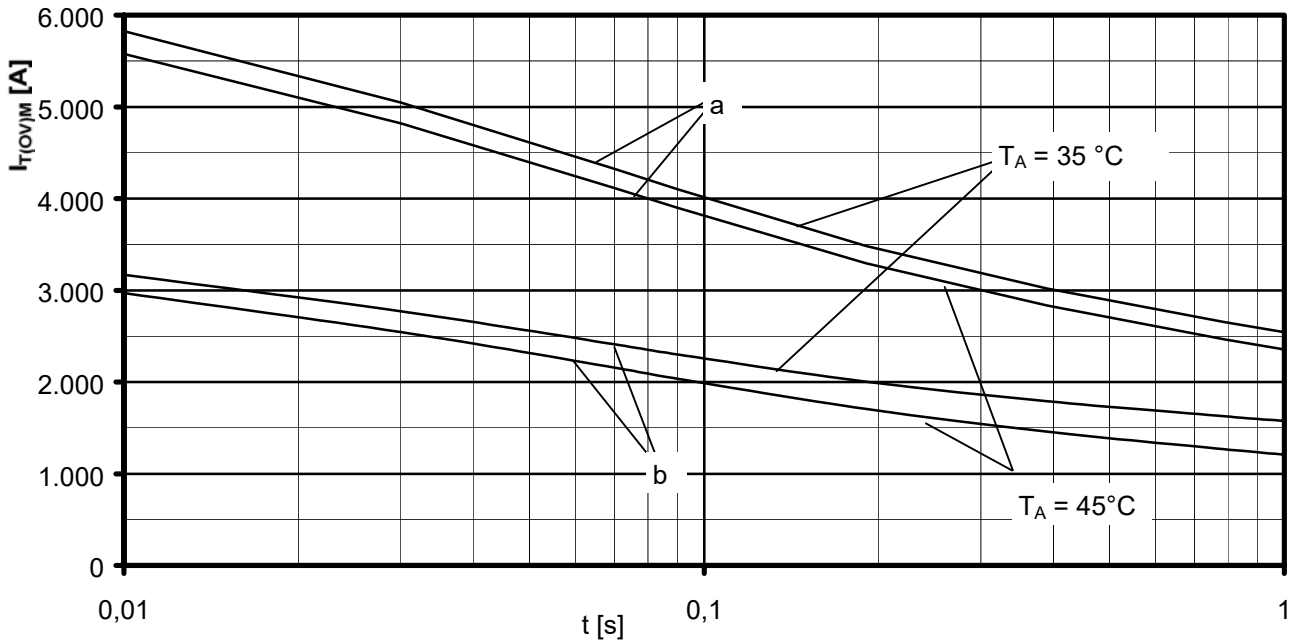


Fig. 15 Maximum overload on-state current $I_{T(OV)M} = f(t)$, $V_{RM} = 0,8 V_{RRM}$
 a: No-load conditions
 b: after load with ITAVM
 $T_A = 35^\circ\text{C}$, Forced air cooling $T_A = 45^\circ\text{C}$, Natural air cooling

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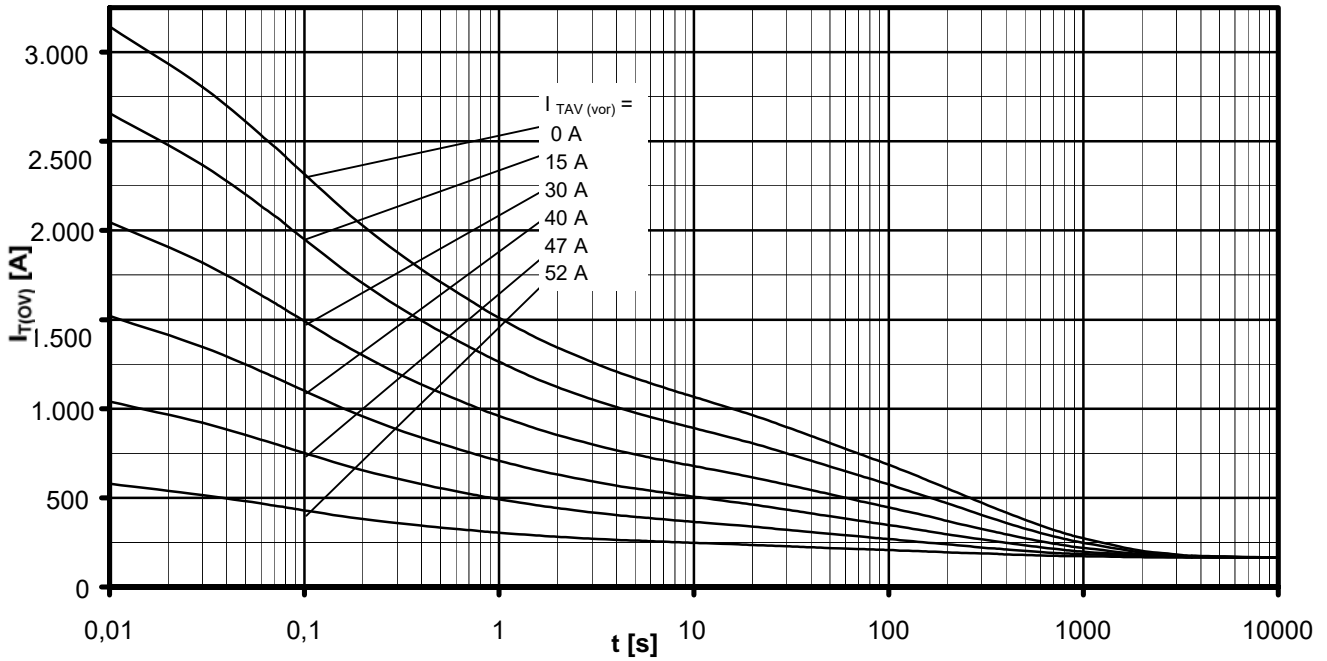


Fig.16 Overload on-state current $I_{T(OV)}$
 Six-pulse bridge circuit, 120° rectangular
 Heatsink type KM17 (45W) Natural cooling at $T_A = 45^\circ$
 C Parameter: Pre-load current per arm $I_{TAV(vor)}$

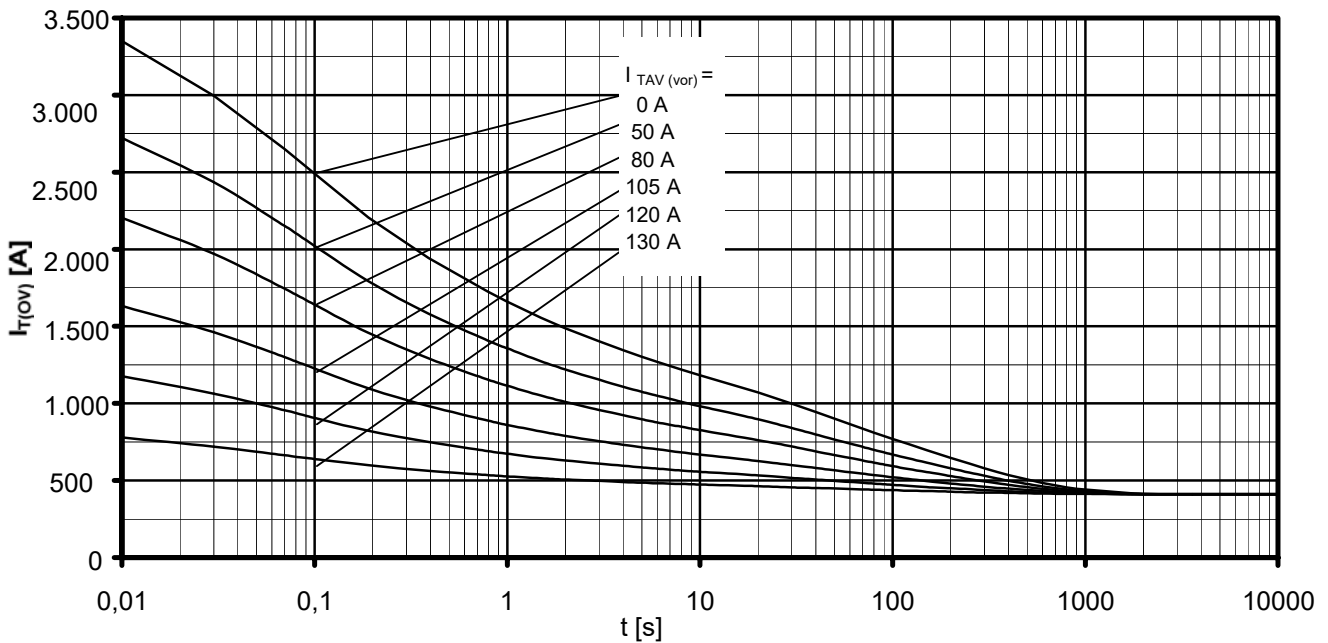


Fig.17 Overload on-state current $I_{T(OV)}$ Six-pulse bridge circuit,
 120° rectangular
 Heatsink type KM17(45W)
 Forced cooling at $T_A = 35^\circ\text{C}$ Parameter:
 Pre-load current per arm $I_{TAV(vor)}$